

### Features

- Floating channel designed for bootstrap operation
- Fully operational to +200V
- Tolerant to negative transient voltage, dV/dt immune
- Gate drive supply range from 10V to 20V
- Undervoltage lockout
- 3.3V, 5V, and 15V logic compatible
- Cross-conduction prevention logic
- Matched propagation delay for both channels
- Internal set deadtime
- High-side output in phase with  $\overline{\text{HIN}}$  input
- Low-side output out of phase with  $\overline{\text{LIN}}$  input
- Leadfree, RoHS compliant
- Automotive qualified\*

### Typical Applications

- Pre-charge Switch Drives
- Stepper / Motor Drives
- DC-DC Converters

### Product Summary

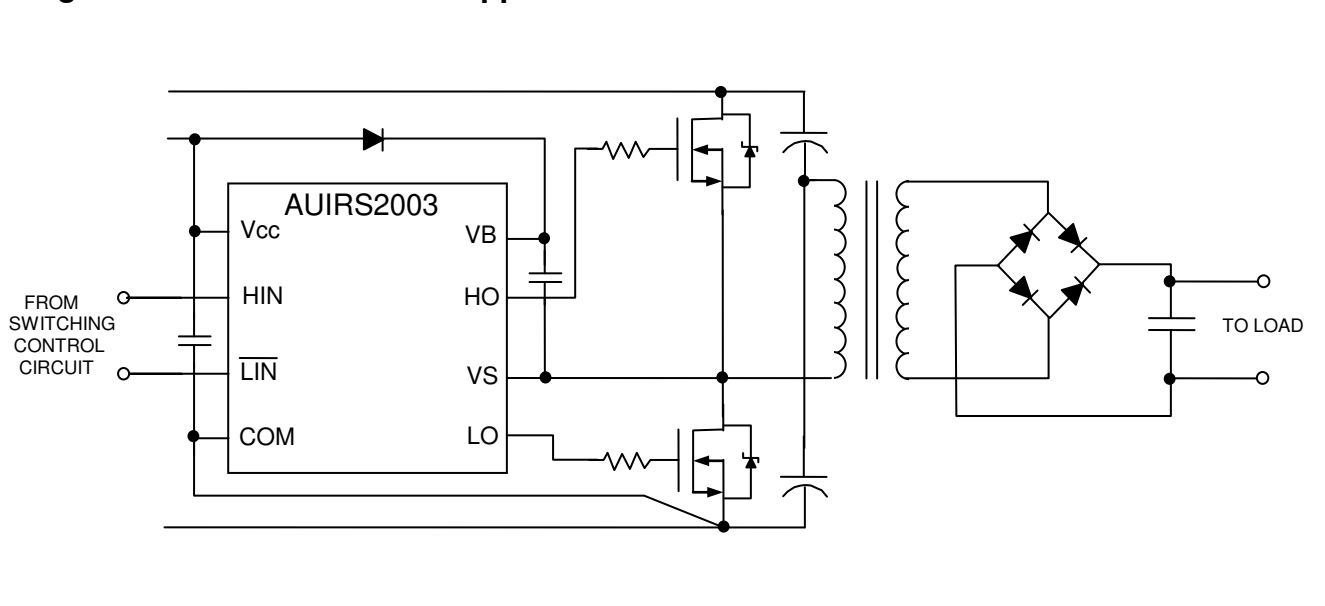
Topology	General Driver
$V_{\text{OFFSET}}$	$\leq 200\text{V}$
$V_{\text{OUT}}$	10V – 20V
$I_{\text{o+}}$ & $I_{\text{o-}}$ (typical)	290mA & 600mA
$t_{\text{on}}$ & $t_{\text{off}}$ (typical)	680ns & 150ns
Deadtime (typical)	520ns

### Package Options



8 - Lead SOIC  
AUIRS2003S

### Diagram for DC-DC converter application

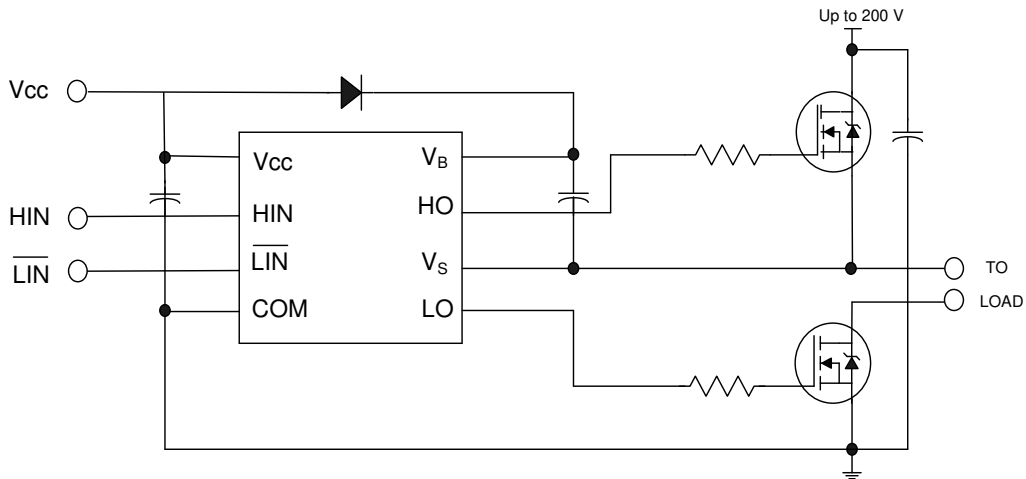


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## Description

The AUIRS2003S is a high voltage, high speed power MOSFET and IGBT driver with dependent high and low side referenced output channels. Proprietary HVIC and latch immune CMOS technologies enable ruggedized monolithic construction. The logic input is compatible with standard CMOS or LSTTL output, down to 3.3V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver cross-conduction. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high side configuration which operates up to 200V.

## Typical Connection Diagram



(Refer to Lead Assignments for correct pin configuration). This/These diagram(s) show electrical connections only. Please refer to our Application Notes and Design Tips for proper circuit board layout.

**Qualification Information<sup>†</sup>**

<b>Qualification Level</b>		Automotive (per AEC-Q100 <sup>††</sup> )	
		Comments: This family of ICs has passed an Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.	
<b>Moisture Sensitivity Level</b>		SOIC8N	MSL3 <sup>†††</sup> 260°C (per IPC/JEDEC J-STD-020)
<b>ESD</b>	Machine Model	Class M2 (per AEC-Q100-003)	
	Human Body Model	Class H2 (per AEC-Q100-002)	
	Charged Device Model	Class C5 (per AEC-Q100-011)	
<b>IC Latch-Up Test</b>		Class II, Level B (per AEC-Q100-004)	
<b>RoHS Compliant</b>		Yes	

† Qualification standards can be found at International Rectifier's web site <http://www.irf.com/>

†† Exceptions to AEC-Q100 requirements are noted in the qualification report.

††† Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.

**Absolute Maximum Ratings**

Absolute Maximum Ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min.	Max.	Units
$V_B$	High side floating absolute voltage	-0.3	225	V
$V_S$	High side floating supply offset voltage	$V_B - 25$	$V_B + 0.3$	
$V_{HO}$	High side floating output voltage	$V_S - 0.3$	$V_B + 0.3$	
$V_{CC}$	Low side and logic fixed supply voltage	-0.3	25	
$V_{LO}$	Low side output voltage	-0.3	$V_{CC} + 0.3$	
$V_{IN}$	Logic input voltage (HIN & LIN)	-0.3	$V_{CC} + 0.3$	
$dV_S/dt$	Allowable offset supply voltage transient	—	50	V/ns
$P_D$	Package power dissipation @ $T_A \leq 25^\circ\text{C}$	—	0.625	W
$R_{thJA}$	Thermal resistance, junction to ambient	—	200	$^\circ\text{C}/\text{W}$
$T_J$	Junction temperature	—	150	$^\circ\text{C}$
$T_S$	Storage temperature	-55	150	
$T_L$	Lead temperature (soldering, 10 seconds)	—	300	

**Recommended Operating Conditions**

The input/output logic timing diagram is shown in Fig 1. For proper operation the device should be used within the recommended conditions. The  $V_S$  offset rating is tested with all supplies biased at 15V differential.

Symbol	Definition	Min.	Max.	Units
$V_B$	High side floating supply absolute voltage	$V_S + 10$	$V_S + 20$	V
$V_S$	High side floating supply offset voltage	†	200	
$V_{HO}$	High side floating output voltage	$V_S$	$V_B$	
$V_{CC}$	Low side and logic fixed supply voltage	10	20	
$V_{LO}$	Low side output voltage	0	$V_{CC}$	
$V_{IN}$	Logic input voltage	0	$V_{CC}$	
$T_A$	Ambient temperature	-40	125	$^\circ\text{C}$

† Logic operational for  $V_S$  of -5V to +200V. Logic state held for  $V_S$  of -5V to  $-V_{BS}$ . (Please refer to the Design Tip DR97-3 for more details).

**Dynamic Electrical Characteristics**

$V_{CC} = V_{BS} = 15V$ ,  $C_L = 1000pF$ ,  $T_A = 25^\circ C$  unless otherwise specified.

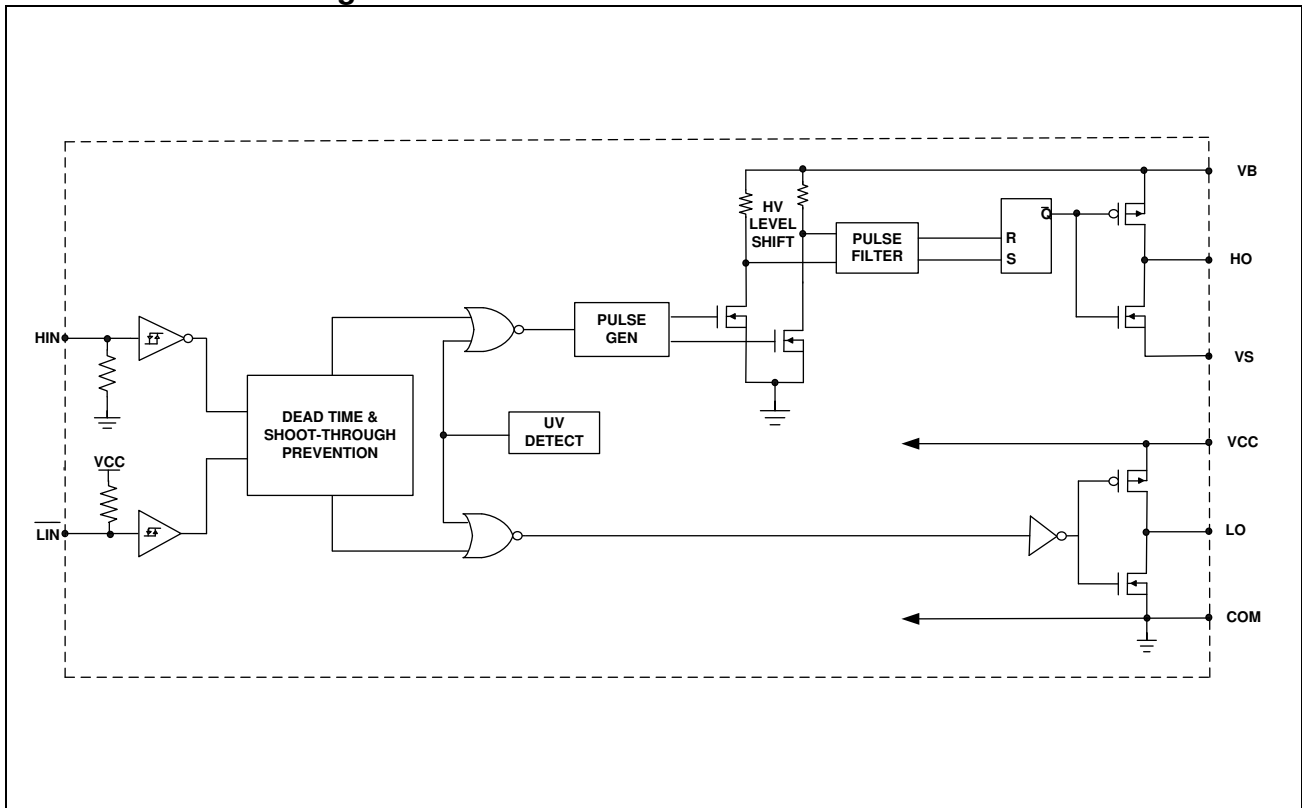
Symbol	Definition	Min	Typ	Max	Units	Test Conditions
$t_{on}$	Turn-on propagation delay	—	680	820	ns	$V_S = 0V$
$t_{off}$	Turn-off propagation delay	—	150	220		$V_S = 200V$
$t_r$	Turn-on rise time	—	70	170		
$t_f$	Turn-off fall time	—	35	90		
DT	Deadtime, LO turn-off to HO turn-on & HO turn-on to LO turn-off	400	520	650		
MT	Delay matching , HO & LO turn-on/off	—	—	60		

**Static Electrical Characteristics**

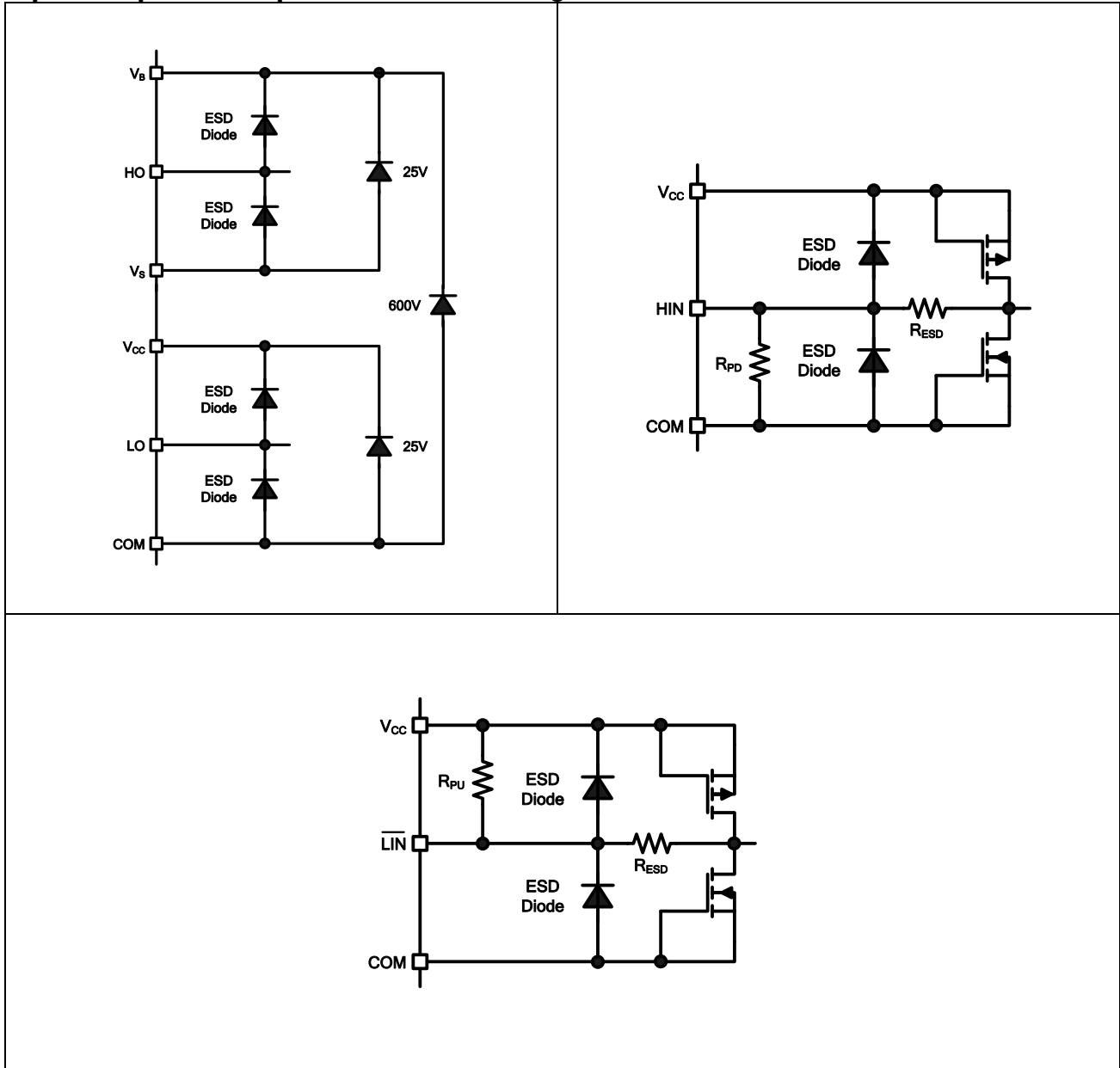
$V_{CC} = V_{BS} = 15V$  and  $T_A = 25^\circ C$  unless otherwise specified. The  $V_{IN}$  and  $I_{IN}$  parameters are referenced to COM and are applicable to the input leads: HIN and LIN. The  $V_O$  and  $I_O$  parameters are referenced to COM and are applicable to the respective output leads: HO and LO.

Symbol	Definition	Min	Typ	Max	Units	Test Conditions
$V_{IH}$	Logic "1" input voltage	2.5	—	—	V	$V_{CC} = 10V$ to $20V$
$V_{IL}$	Logic "0" input voltage	—	—	0.8		
$V_{OH}$	High level output voltage, $V_{CC}$ or $V_{BS} - V_O$	—	0.05	0.2		
$V_{OL}$	Low level output voltage, $V_O$	—	0.02	0.1		
$I_{LK}$	Offset supply leakage current	—	—	50	$\mu A$	$V_B = V_S = 200V$
$I_{QBS}$	Quiescent $V_{BS}$ supply current	—	30	55		$V_{IN} = 0V$ or $5V$
$I_{QCC}$	Quiescent $V_{CC}$ supply current	—	150	270		$V_{IN} = 5V$
$I_{IN+}$	Logic "1" input bias current	—	3	10		$V_{IN} = 0V$
$I_{IN-}$	Logic "0" input bias current	—	—	5		
$V_{CCUV+}$	$V_{CC}$ supply undervoltage positive going threshold	8.0	8.9	9.8	V	
$V_{CCUV-}$	$V_{CC}$ supply undervoltage negative going threshold	7.4	8.2	9.0		
$I_{O+}$	Output high short circuit pulsed current	130	290	—	mA	$V_O = 0V$ , $V_{IN} = V_{IH}$ $PW \leq 10 \mu s$
$I_{O-}$	Output low short circuit pulsed current	270	600	—		$V_O = 15V$ , $V_{IN} = V_{IL}$ $PW \leq 10 \mu s$

**Functional Block Diagram**



**Input/Output Pin Equivalent Circuit Diagrams**

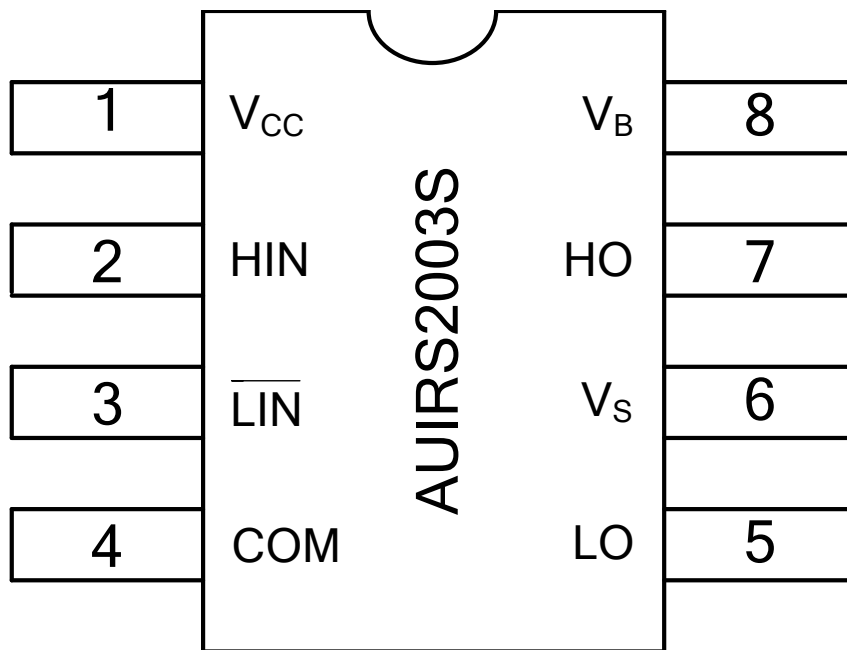




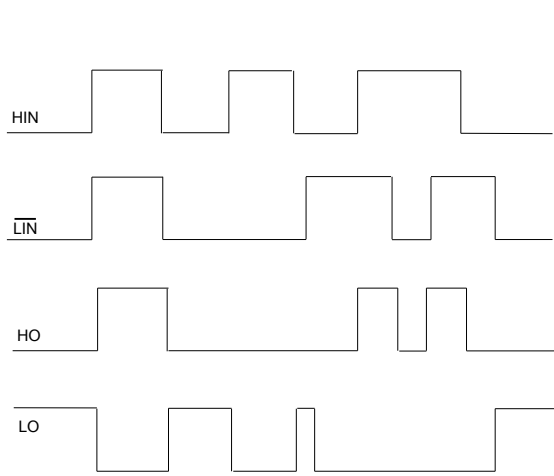
**Lead Definitions**

PIN	Symbol	Description
1	$V_{CC}$	Low side and logic fixed supply
2	HIN	Logic input for high side gate driver output (HO), in phase
3	$\overline{LIN}$	Logic input for low side driver output (LO), out of phase
4	COM	Low side return
5	LO	Low side gate drive output
6	$V_S$	High side floating supply return
7	HO	High side gate drive output
8	$V_B$	High side floating supply

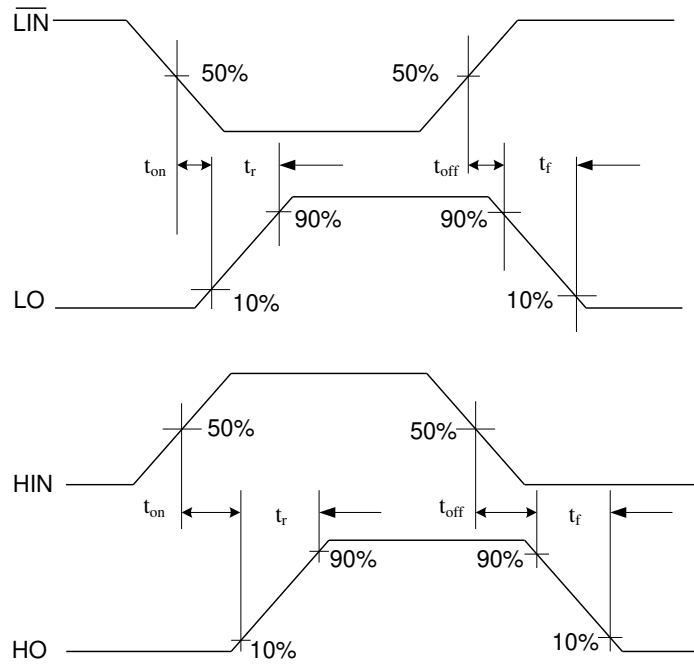
**Lead Assignments**



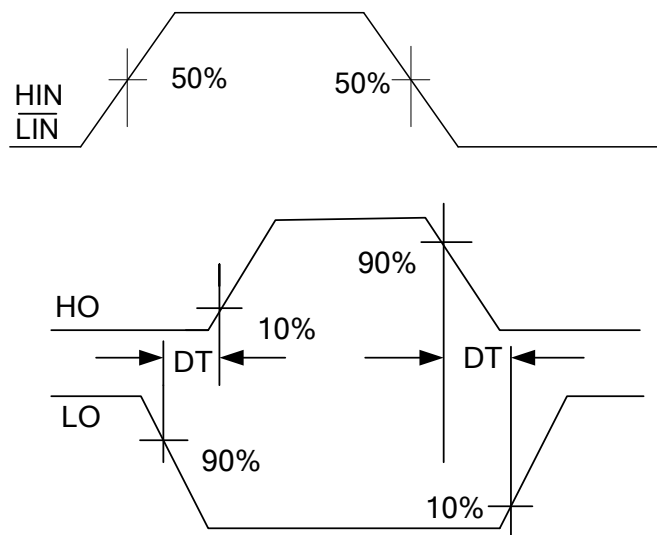
**Application Information and Additional Details**



**Figure 1: Input/Output Timing Diagram**

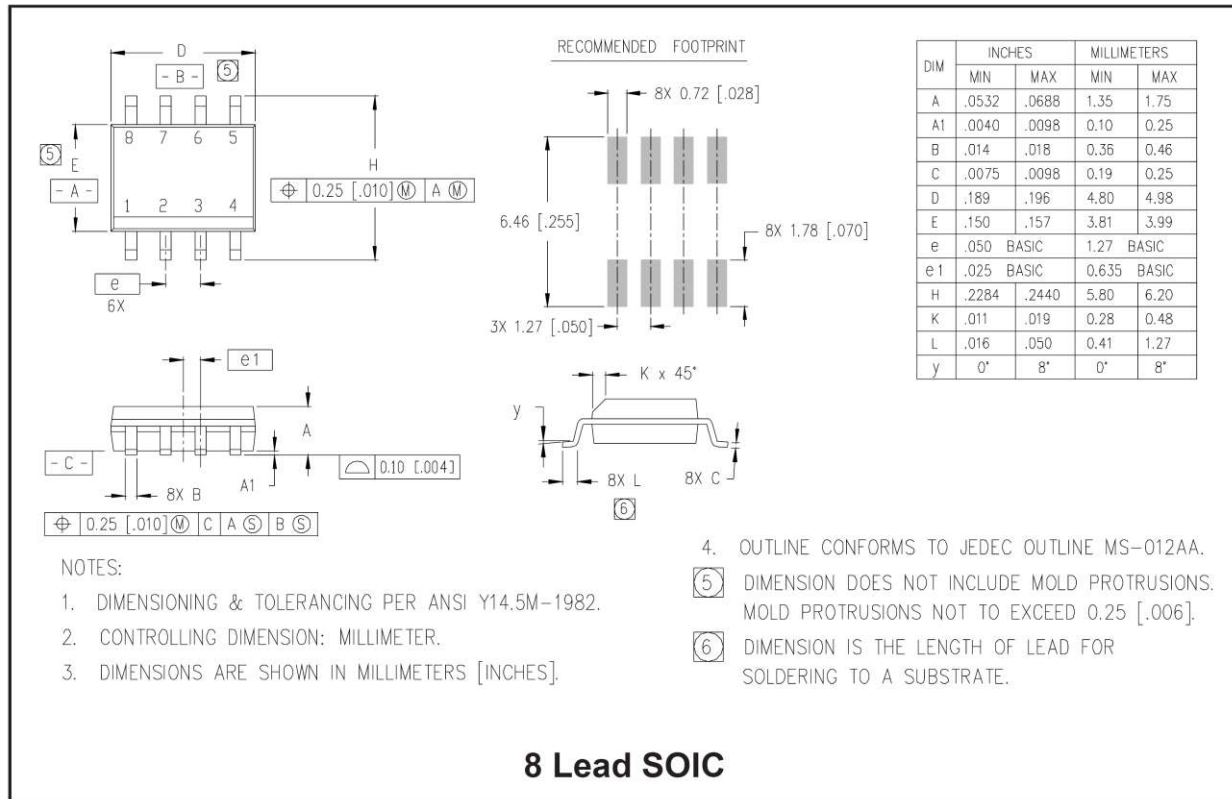


**Figure 2: Switching Time Waveform Definition**



**Figure 3: Delay Matching Waveform Definitions**

**Package Details: SOIC8N**

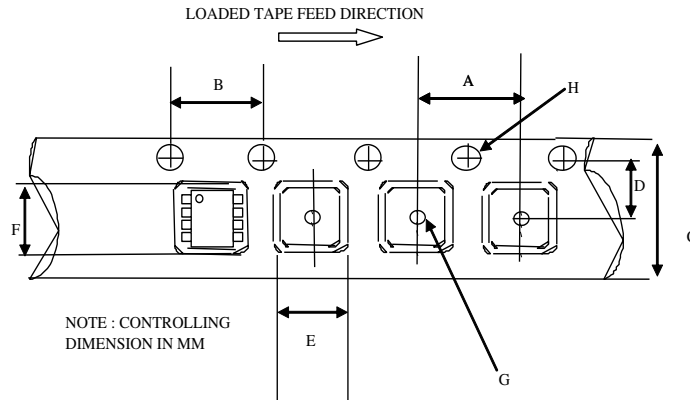


NOTES:

1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].

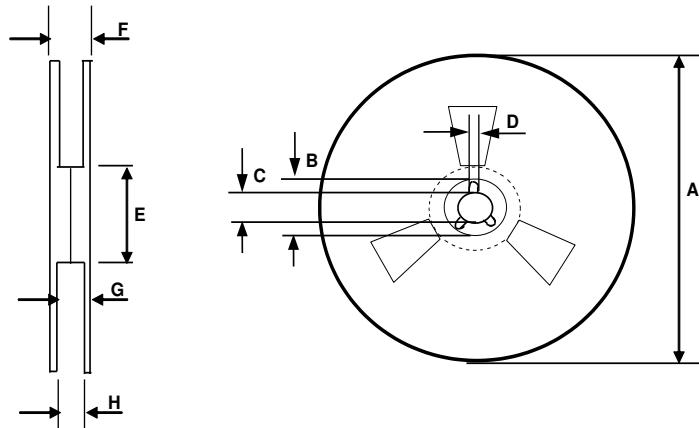
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
5. DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 [.006].
6. DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.

**Package Details: SOIC8N, Tape and Reel**



CARRIER TAPE DIMENSION FOR 8SOICN

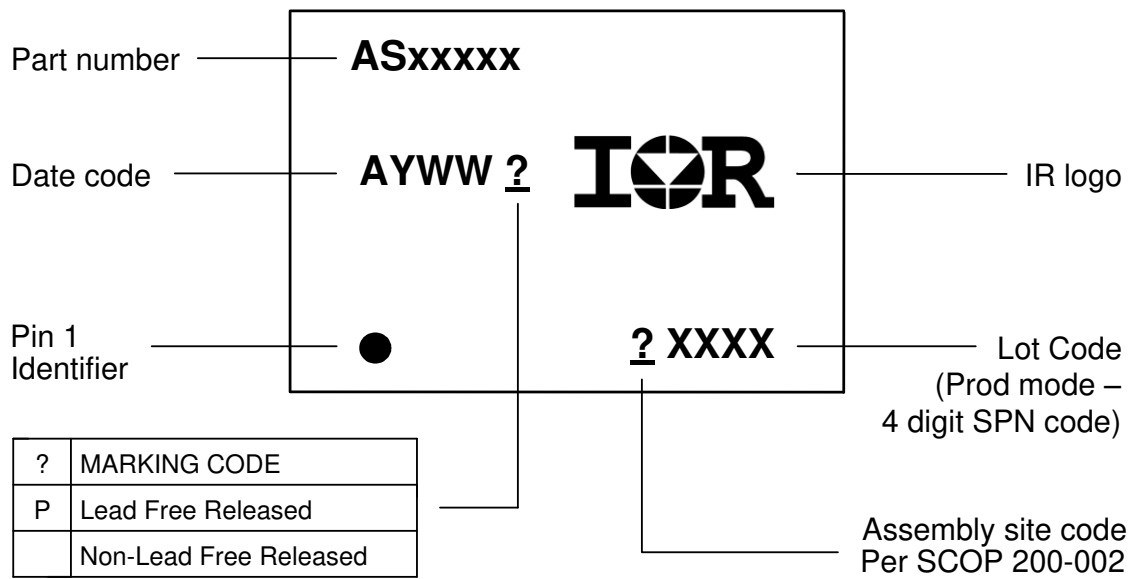
Code	Metric		Imperial	
	Min	Max	Min	Max
A	7.90	8.10	0.311	0.318
B	3.90	4.10	0.153	0.161
C	11.70	12.30	0.46	0.484
D	5.45	5.55	0.214	0.218
E	6.30	6.50	0.248	0.255
F	5.10	5.30	0.200	0.208
G	1.50	n/a	0.059	n/a
H	1.50	1.60	0.059	0.062



REEL DIMENSIONS FOR 8SOICN

Code	Metric		Imperial	
	Min	Max	Min	Max
A	329.60	330.25	12.976	13.001
B	20.95	21.45	0.824	0.844
C	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	18.40	n/a	0.724
G	14.50	17.10	0.570	0.673
H	12.40	14.40	0.488	0.566

**Part Marking Information**



**Ordering Information**

Base Part Number	Package Type	Standard Pack		Complete Part Number
		Form	Quantity	
AUIRS2003S	SOIC8	Tube/Bulk	95	AUIRS2003S
		Tape and Reel	2500	AUIRS2003STR

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